

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	109	257/e21.071.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/27 08:20
L3	36	(438/553).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/27 08:21
L4	454	(118/696).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/27 08:30
L5	1644	(118/52).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/27 08:30
L6	1321	(118/58).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/27 08:30
L7	395	(396/611).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/27 08:30
S2	6	apparatus with (heating adj plate) with heater with frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:11

S3	59	apparatus same (heating adj plate) same heater same frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:27
S4	820	apparatus and (heating adj plate) and heater and frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:28
S5	0	apparatus near (heating adj plate) near heater near frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/01 14:12
S6	6	apparatus with (heating adj plate) with heater with frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/02 18:18
S7	59	apparatus same (heating adj plate) same heater same frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:11
S9	7	apparatus and (mask\$5 adj substrate) and (heating adj plate) and heater and frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/05 10:40
S10	1	(takei.inv. and toshichika) and apparatus and (mask\$5 adj substrate) and (heating adj plate) and heater and frame	US-PGPUB; USPAT	OR	ON	2006/05/02 18:34
S11	12	(takei.inv. and toshichika) and apparatus	US-PGPUB; USPAT	OR	ON	2006/05/02 18:42
S12	3	(takei.inv. and toshichika) and apparatus and (mask\$5 adj substrate)	US-PGPUB; USPAT	OR	ON	2006/05/02 18:42
S13	7	(apparatus or system or assembly) and (mask\$5 adj substrate) and (heating adj plate) and heater and frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/02 18:45

S14	855	apparatus and (heating adj plate) and heater and frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/05 13:41
S15	6	apparatus with (heating adj plate) with heater with frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/05 10:42
S16	59	apparatus same (heating adj plate) same heater same frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/05 13:37
S17	12	apparatus and (heating adj plate) and (heater near frame)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/05 13:43
S18	120	apparatus and (heating adj plate) and (heater with frame)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/05 13:44
S19	6	apparatus with (heating adj plate) with heater with frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:29
S20	59	apparatus same (heating adj plate) same heater same frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:27
S21	570	(apparatus and (heating adj plate) and heater and frame) and (clearance or space)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:32

S23	43	(apparatus and (heating adj plate) and heater and frame) same (clearance or space)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:28
S24	13	(apparatus and ((heating adj plate) near substrate) and heater and frame) and (clearance or space)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:31
S25	3	(apparatus and ((heating adj plate) near substrate) and heater and frame) and (clearance or space) and @ad<="20030210"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:32
S26	9	(apparatus and ((heating adj plate) near substrate) and heater and frame) and (clearance or space) and @ad<="20040210"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:34
S27	358	(apparatus and (heating adj plate) and heater and frame) and (clearance or space) and @ad<="20030210"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 10:32
S28	7	apparatus with (heating adj plate) with heater with frame	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:16
S29	14	(apparatus same (heating adj plate) same heater same frame) and @ad<="20031002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:18
S30	616	(apparatus and (heating adj plate) and heater and frame) and @ad<="20031002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:13

S32	291	(heating adj plate) and heater and frame and peripheral and @ad<="20031002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:19
S33	113	(apparatus same (heating adj plate) same heater same (frame or housing or support\$3)) and @ad<="20031002"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:25
S34	227	(heating adj plate) and heater and frame and peripheral and @ad<="20031002" and apparatus	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:25
S35	24	(heating adj plate) and heater and frame and peripheral and @ad<="20031002" and apparatus and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/15 08:48
S36	29	(apparatus same (heating adj plate) same heater same (frame or housing or support\$3)) and @ad<="20031002" and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/13 13:25
S37	3	(heating adj plate) and heater and frame and peripheral and @ad<="20031002" and apparatus and wafer and overlap\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/08 15:39
S41	4	(("6881058") or ("6743395")).PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/16 10:35
S42	24	(heating adj plate) and heater and frame and peripheral and @ad<="20031002" and apparatus and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/08 16:19
S43	1	("5081563").PN.	USPAT	OR	OFF	2007/08/11 07:15

S44	0	(heating adj plate) and heater and (frame with gap) and peripheral and @ad<="20031002" and apparatus and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/08 16:20
S45	0	(heating adj plate) and heater and (frame near gap) and peripheral and @ad<="20031002" and apparatus and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/08 16:20
S46	3	(heating adj plate) and heater and (frame same gap) and peripheral and @ad<="20031002" and apparatus and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/08 16:20
S47	19	(heating adj plate) and heater and (frame and gap) and peripheral and @ad<="20031002" and apparatus and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/08 16:21
S48	1	("6072162").PN.	USPAT	OR	OFF	2007/08/11 07:15
S49	2	(("6022257") or ("6822311")).PN.	USPAT	OR	OFF	2007/11/26 12:52
S50	1	("6274465").PN.	USPAT	OR	OFF	2007/11/26 12:59
S51	1	("6459140").PN.	USPAT	OR	OFF	2007/11/27 10:13
S52	1	("5006477").PN.	USPAT	OR	OFF	2007/11/27 10:30
S53	628	(432/11).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/25 22:40
S54	770	(432/241).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/25 22:41
S55	3	(apparatus and (heating adj plate) and heater and frame) with (clearance or space)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/25 22:41

S56	0	"432"/\$.ccls. and (apparatus with (heating adj plate) with heater with frame)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/25 22:43
S57	2	"432"/\$.ccls. and (apparatus same (heating adj plate) same heater same frame)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/25 22:43
S58	23	"432"/\$.ccls. and (apparatus and (heating adj plate) and heater and frame)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/25 22:43
S59	17	(apparatus and (heating adj plate) and heater and frame).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/05/25 22:44
S60	5	(apparatus and (heating adj plate) and heater and frame).clm.	US-PGPUB	OR	ON	2008/05/25 22:44
S61	729	(432/253).CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/05/25 22:47

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